

67,200-409; TSMC 00-661
Serial Number 09/978,420

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

TO: Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

FROM: Tung & Associates
838 West Long Lake Road - Suite 120
Bloomfield Hills, MI 48302

DATE: 30 October 2003

OFFICIAL

REF: Applicant : Chou et al Filing Date : 15 October 2001
Serial No : 09/978,420 Att'y No. : 67,200-409
Art Unit : 2815 Examiner : N Drew Richards
Title : Microelectronic Fabrication With Upper Lying Aluminum
Fuse Layer in Copper Interconnect Semiconductor Technology
and Method for Fabrication Thereof

AMENDMENT FOR FILING WITH APPEAL BRIEF

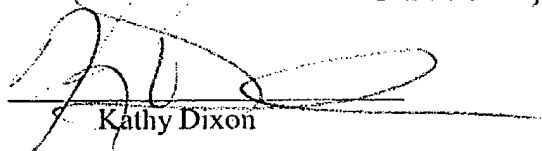
Sir:

In response to an office action mailed 30 July 2003 and made FINAL, in conjunction with the accompanying appeal brief and in accord with MPEP 1207, please consider the following amendments and remarks pertaining to the above referenced application.

There are no amendments to the specification or the drawings. Amendments to the claims are found within the Listing of the Claims that begins on page 2 of this paper. Remarks begin on page 4 of this paper.

CERTIFICATE OF FACSIMILE TRANSMISSION

I hereby certify that this correspondence is being facsimile transmitted to the United States Patent and Trademark Office at facsimile number 703-872-9319, on Dec. 30, 2003.


Kathy Dixon

**TUNG &
ASSOCIATES**
Intellectual Property Law

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Date: December 30, 2003

**TO: Examiner N. Drew Richards (703) 872-9319
Art Unit: 2815**

FAX Operator: Kathy Dixon

FAX Number: (248) 540-4035

Telephone Number: (248) 540-4040

Subject Matter: 09/ 978,420

Attorney Doc: 67,200-409

Message:

Total number of pages sent: - **8** - (including this cover sheet)